



Qualcomm Technologies, Inc.

## **Cover Page**

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**February 12, 2019**

Qualcomm  
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tommy.kim@kr.wpgholdings.com

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ECCN: EAR99

**Qualcomm Technologies, Inc.  
5775 Morehouse Drive  
San Diego, CA 92121  
U.S.A.**



**CDMA Technologies Asia-Pacific Pte. Ltd.**

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**6 Serangoon North Avenue 5, #03-04 Serangoon North Ind Estate  
Singapore 554910**

Dear Customer:

This letter is in response to your request for material information for Qualcomm CDMA Technologies Asia-Pacific (QCTAP) product(s).

Please note that nothing in this letter or our response constitutes any guaranty, commitment, affirmation, or certification by our division or company. Rather, this letter and our response are for your informational purposes only and are provided "AS IS", without any express or implied warranty of any kind whatsoever. This letter and the attached form shall not in any way be construed as altering the applicable terms and conditions under which we supply any QCTAP product to you. All rights and obligations with respect to any particular product provided by us to you are solely as defined in the definitive, written supply or license agreement between our companies for such product.

We believe that the information we are providing regarding the chemical substances in our products is accurate. The information in our response is based on information provided to us by our suppliers, other third parties and information in our existing records. We are not able to verify the accuracy or completeness of information provided to us by third parties. The manufacturer's name and trade name of the material tested have been removed from the enclosed test reports. QCTAP considers the names confidential and proprietary. When the material description is not available on the report document, a general description has been added to describe the material (e.g., mold compound, die attach, etc.). The removal of names and addition of material description in no way alters the analytical test results of the material tested.

Our responses are as of the date hereof and we undertake no obligation to update or modify the information and we do not intend to do so.

The information being sent to you is confidential information of QCTAP and is being sent to you subject to the terms and conditions of the mutual non-disclosure agreement between our two companies.

Please contact Michelle Lee, 1-858-845-7808 [mmlee@qti.qualcomm.com](mailto:mmlee@qti.qualcomm.com), if you require further clarifications.

Sincerely,

A handwritten signature in purple ink, appearing to read "Michelle Lee".

Michelle Lee  
Sr. Staff Engineer/ CSR & EMS Champion